

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	22kΩ
R_2	47kΩ

Features

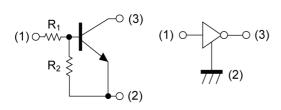
- 1) Built-In Biasing Resistors, $R_1 = 22k\Omega$, $R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA124X series

Application

INVERTER, INTERFACE, DRIVER

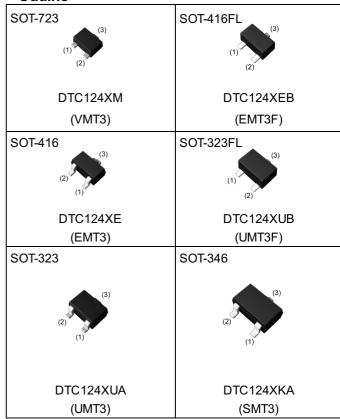
Inner circuit

DTC124XM/ DTC124XEB/ DTC124XUB

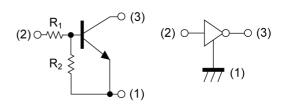


- (1) IN (BASE)
- (2) GND (EMITTER)
- (3) OUT (COLLECTOR)

Outline



DTC124XE/ DTC124XUA/ DTC124XKA



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC124XM	SOT-723	1212	T2L	180	8	8000	45
DTC124XEB	SOT-416FL	1616	TL	180	8	3000	45
DTC124XE	SOT-416	1616	TL	180	8	3000	45
DTC124XUB	SOT-323FL	2021	TL	180	8	3000	45
DTC124XUA	SOT-323	2021	T106	180	8	3000	45
DTC124XKA	SOT-346	2928	T146	180	8	3000	45

● **Absolute maximum ratings** (T_a = 25°C)

Pa	rameter	Symbol	Values	Unit
Supply voltage	V _{CC}	50	V	
Input voltage	V _{IN}	-10 to 40	V	
Output current			50	mA
Collector current			100	mA
	DTC124XM		150	
	DTC124XEB		150	mW
Davis a disaination	DTC124XE	P _D *2	150	
Power dissipation	DTC124XUB	P _D -	200	
	DTC124XUA		200	
DTC124XKA			200	
Junction temperature		T _j	150	°C
Range of storage temperate	ure	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Input voltage	$V_{l(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.4	V	
Input voltage	V _{I(on)}	$V_{O} = 0.3V, I_{O} = 2mA$	2.5	-	-	V	
Output voltage	V _{O(on)}	I _O = 10mA, I _I = 0.5mA	1	100	300	mV	
Input current	I _I	V _I = 5V	1	-	360	μA	
Output current	I _{O(off)}	$V_{CC} = 50V, V_{I} = 0V$	1	-	500	nA	
DC current gain	G _I	$V_{O} = 5V, I_{O} = 5mA$	68	-	-	-	
Input resistance	R ₁	-	15.4	22	28.6	kΩ	
Resistance ratio	R ₂ /R ₁	-	1.7	2.1	2.6	-	
Transition frequency	f _T *1	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz	

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

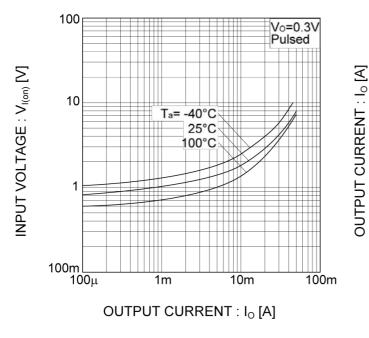


Fig.2 Output current vs. input voltage (OFF characteristics)

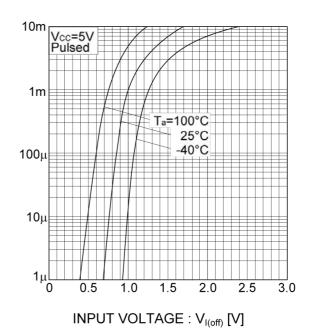


Fig.3 Output current vs. output voltage

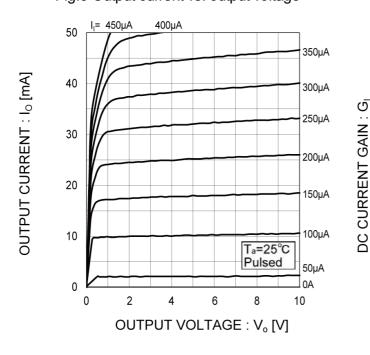
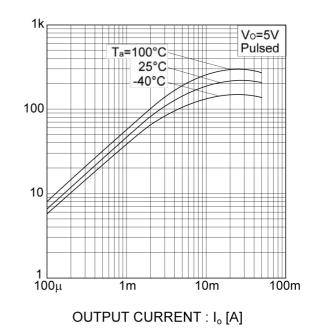
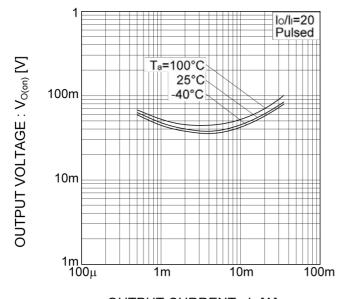


Fig.4 DC current gain vs. output current

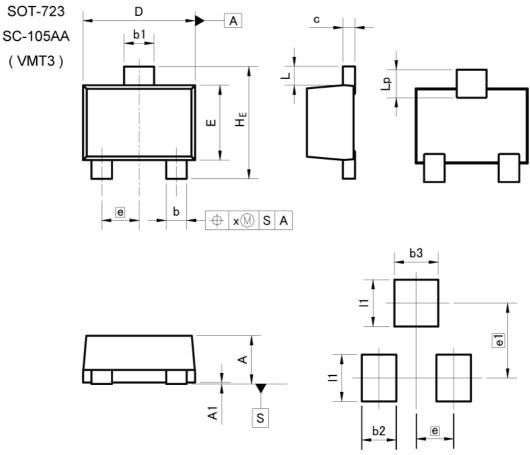


●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]



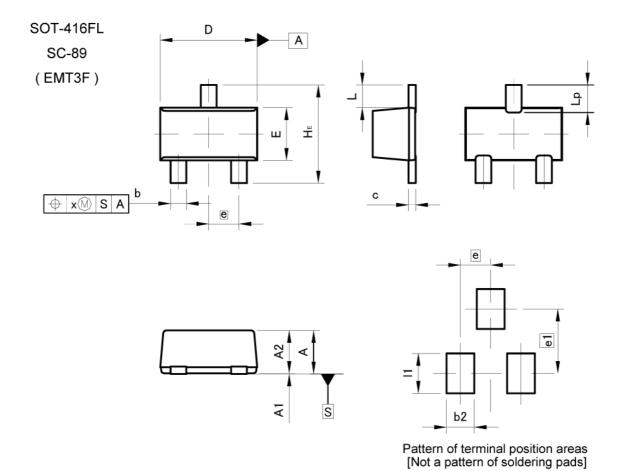
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	11 0	0.37	544	0.015
b3	226	0.47	922	0.019
e1	0.	80	0.031	
11	5 8	0.50	200	0.020

Dimension in mm/inches



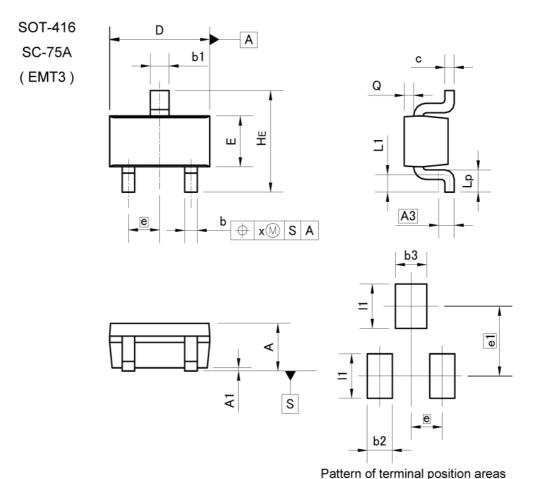


DIM -	MILIM	ETERS	INC	HES
DIM L	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.50 0.0		20	
HE	1.50	1.70	0.059	0.067
L	0.37		0.0	15
Lp	0.35	0.55	0.014	0.022
х		0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	= 1	0.46	-	0.018
e1		1.05	_	0.041
11	#	0.65		0.026

Dimension in mm/inches





MILIMETERS INCHES DIM MIN MAX MIN MAX A 0.60 0.80 0.024 0.031 A1 0.00 0.10 0.000 0.004 A3 0.25 0.010 b 0.15 0.30 0.006 0.012 0.40 0.010 0.016 b1 0.25 0.20 0.004 0.008 0.10 C 1.50 1.70 0.059 0.067 D 0.70 0.90 0.028 0.035 Ε e 0.055 HE 1.40 1.80 0.071 L1 0.10 0.004 0.006 Lp 0.15 0.25 0.05 0.002 0.010

DIM	MILIMETERS		INC	HES
	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 48	0.50	; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; 	0.020
e1	1.10		0.0	043
11	12 -	0.70	_	0.028

0.10

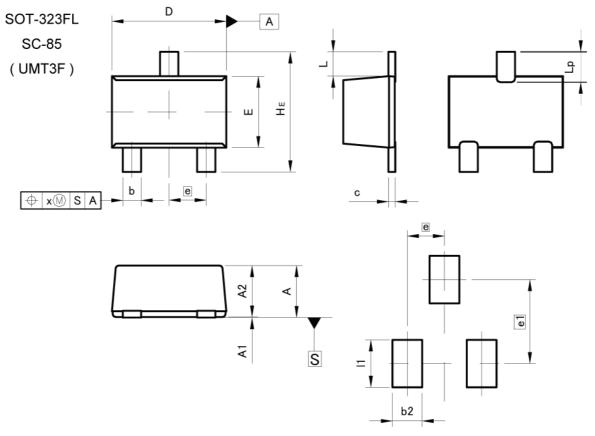
Dimension in mm/inches

Q



0.004

[Not a pattern of soldering pads]



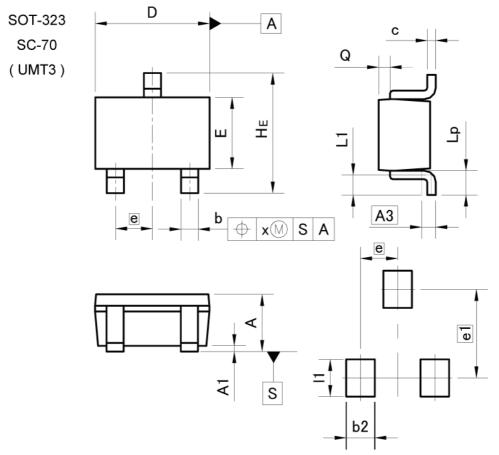
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.4	25	0.0	17
Lp	0.43	0.63	0.017	0.025
х	===	0.10	:=:	0.004

DIM	MILIME	TERS	INCH	HES
DIM	MIN	MAX	MIN	MAX
b2	- s	0.52	-	0.020
e1	1.47		0.0	58
11	 k	0.83	-	0.033

Dimension in mm/inches





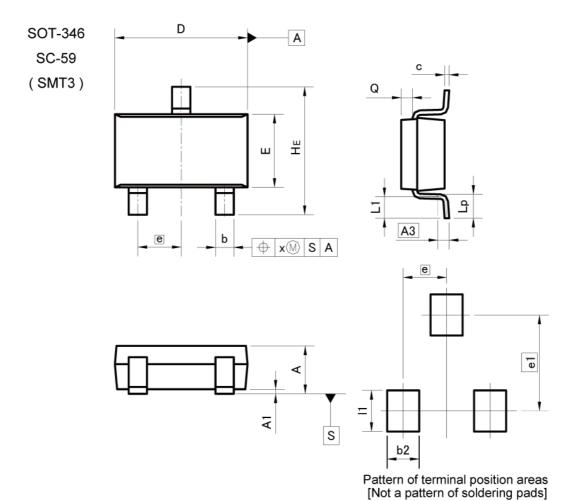
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INCH	HES
DIM [MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.2	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	ô5	0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u>22</u> 9	0.50	-	0.020
e1	1.55		0.061	
11		0.65	-	0.026

Dimension in mm/inches





DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-3	0.10	47	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2		0.60	N 	0.024
e1	2.10		0.083	
11		0.90	-	0.035

0.10

Dimension in mm/inches



0.004

Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSII	CLASS II b	CLASSIII
CLASSIV		CLASSIII	CLASSIII

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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 - [h] Use of the Products in places subject to dew condensation
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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Notice-PGA-E Rev.003

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Rev.001

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SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F) RN4605(TE85L,F) TTEPROTOTYPE79

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SMUN5230DW1T1G SMUN5133T1G SMUN2214T1G DTC114EUA-TP NSBA144EF3T5G NSVDTA114EET1G 2SC2223-T1B-A

2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G NSVMUN5135DW1T1G

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